



115
Receipt

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of: **Akihisa INOUE et al.**

Group Art Unit: **1742**

Serial Number: **10/525,738**

Examiner: **Not yet Assigned**

Filed: **September 20, 2005**

Confirmation No.: **8319**

For: **Cu-BASE AMORPHOUS ALLOY**

Attorney Docket Number: **043197**

Customer Number: **38834**

REQUEST FOR CORRECTED FILING RECEIPT

Mail Stop: Missing Parts
Commissioner for Patents
P. O. Box 1450
Alexandria, VA 22313-1450

April 19, 2006

Sir:

Please supply the undersigned attorney with a corrected filing receipt for the above-identified application. The undersigned also respectfully requests that the Patent and Trademark Office records be amended to reflect the correction.

In reviewing the Official Filing Receipt, we noted an error in **Assignment for Published Patent Application**. The Assignee's Information should read **--JAPAN SCIENCE AND TECHNOLOGY AGENCY, Kawaguchi-shi, Japan--**. A **Supplemental Application Data Sheet** is enclosed which indicates the correct information.

Request for Corrected Filing Receipt

10/525,738

043197

If any fees are required in connection with this paper, please charge Deposit Account No.

50-2866.

Respectfully submitted,

WESTERMAN, HATTORI, DANIELS & ADRIAN, LLP

A handwritten signature in black ink, appearing to read "Sadao Kinashi". The signature is fluid and cursive, with the first name "Sadao" and last name "Kinashi" clearly distinguishable.

Sadao Kinashi

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Enclosures: Supplemental Application Data Sheet

Supplemental Application Data Sheet



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Supplemental Application Data Sheet



Application Information

Title Line One: Cu-BASE AMORUPHOUS ALLOY

Total Drawing Sheets: 3

Docket Number: 043197

Application Type: Utility

Serial Number: 10/525,738

Filing Date: September 20, 2005

Total Claims: 2

Filing Fee: 1030

Entity Status: Large

Representative Information

Customer No.: 38834

Domestic Priority Information

This application is a: National Stage of

Application One: PCT/JP2003/7460

Filing Date: June 12, 2003

Foreign Priority Information

Foreign Application One: 2002-255529

Filing Date: August 30, 2002

Country: Japan

Priority Claimed: Yes

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